



Designation: D 5574 – 94 (Reapproved 1999)^{ε1}

Standard Test Methods for Establishing Allowable Mechanical Properties of Wood- Bonding Adhesives for Design of Structural Joints¹

This standard is issued under the fixed designation D 5574; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ε) indicates an editorial change since the last revision or reapproval.

ε¹ NOTE—Keywords were added in April 1999.

1. Scope

1.1 These test methods cover the principles for establishing allowable mechanical properties for adhesives that can be used to design adhesive-bonded joints for structural components and assemblies of wood or wood with other materials. These test methods are modeled after Test Method D 245.

1.2 The properties determined are allowable shear stress, allowable tensile stress, and allowable shear modulus.

1.3 In determination of allowable shear- and tensile-stress levels, these test methods are limited by the horizontal shear and tension perpendicular-to-the-grain capacity of the wood adherends (hard maple, *Acer saccharum*, Marsh.). The adhesives so tested may actually have shear or tensile allowable stresses exceeding the wood, but the determined allowable design stress levels are limited (upper bounded) by the wood in these test methods. If a wood other than hard maple is used for testing the adhesive, then the allowable strengths are upper bounded by the properties of that particular wood.

1.4 The strength properties are determined by standard ASTM test methods. As a result, only procedural variations from the standards and special directions for applying the results are given in these test methods.

1.5 Time-to-failure data derived from creep-rupture testing (see Test Method D 4680) provide a measure of the ultimate strength of an adhesive bond as a function of time at various levels of temperature and moisture.

1.5.1 With proper caution, useful service life at a given shear stress level may be extrapolated from relatively short loading periods.

1.6 The resistance of the adhesive to permanent loss of properties due to aging (permanence) is assessed by means of strength tests after constant elevated-temperature and moisture aging of test specimens.

1.6.1 If the subject adhesives will be used to bond wood that has been treated with a preservative, fire retardant, or any other chemical to modify its properties, then the permanence of the adhesive shall be tested using wood adherends treated in the same manner.

1.7 Factors for durability, permanence, and creep derived by shear tests and analysis, are assumed to apply to tension (normal-to-the-bond) strength as well.

1.8 Requirements for production, inspection, and certification of adhesives evaluated under these test methods are not included.

1.9 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.*

2. Referenced Documents

2.1 ASTM Standards:

D 245 Practice for Establishing Structural Grades and Related Allowable Properties for Visually Graded Lumber²

D 897 Test Method for Tensile Properties of Adhesive Bonds³

D 905 Test Method for Strength Properties of Adhesive Bonds in Shear by Compression Loading³

D 907 Terminology of Adhesives³

D 1101 Test Methods for Integrity of Glue Joints in Structural Laminated Wood Products for Exterior Use³

D 1151 Test Method for Effect of Moisture and Temperature on Adhesive Bonds³

D 2555 Test Methods for Establishing Clear Wood Strength Values²

D 2559 Specification for Adhesives for Structural Laminated Wood Products for Use Under Exterior (Wet Use) Exposure Conditions³

¹ These test methods are under the jurisdiction of ASTM Committee D-14 on Adhesives and are the direct responsibility of Subcommittee D14.70 on Construction Adhesives.

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² Annual Book of ASTM Standards, Vol 04.10.

³ Annual Book of ASTM Standards, Vol 15.06.

- D 2915 Practice for Evaluating Allowable Properties for Grades of Structural Lumber²
- D 3931 Practice for Determining Strength of Gap-Filling Adhesive Bonds in Shear by Compression Loading³
- D 3983 Test Method for Measuring Strength and Shear Modulus of Nonrigid Adhesives by the Thick-Adherend Tensile-Lap Specimen³
- D 4027 Test Method for Measuring Shear Properties of Structural Adhesives by the Modified-Rail Test³
- D 4502 Test Method for Heat and Moisture Resistance of Wood-Adhesive Joints³
- D 4680 Test Method for Creep and Time to Failure of Adhesives in Static Shear by Compression Loading (Wood-to-Wood)³
- D 4896 Guide for Use of Adhesive-Bonded Single Lap-Joint Specimen Test Results³
- E 380 Practice for Use of the International System of Units (SI) (The Modernized Metric System)⁴

3. Terminology

3.1 Definitions:

3.1.1 *allowable design stress, n*—a stress to which a material can be subjected under stated service conditions with low probability of mechanical failure within the design lifetime.

(D 4896)

3.1.1.1 *Discussion*—Allowable design stress is obtained by multiplying the basic stress by a safety factor and possibly one or more modification factors as required by the intended service environment.

3.1.2 *allowable shear stress, n*—in an adhesive-bonded joint, the allowable design stress for structural joints subjected to shear force.

3.1.3 *allowable tensile stress, n*—in an adhesive-bonded joint, the allowable design stress for structural joints subjected to tension force.

3.1.4 *creep rupture, n*—the fracture of a material resulting from a sustained stress (or sum of stresses) above the creep rupture limit.

3.1.4.1 *Discussion*—The material may experience creep through the primary, secondary, and tertiary stages of rupture.

3.1.5 *creep-rupture limit, n*—the stress level below which creep rupture will not occur within a given time in a specified environment. See *creep rupture*.

3.1.6 *durability, n*—as related to adhesive joints, the endurance of joint strength relative to the required service conditions.

(D 907)

3.1.6.1 *Discussion*—Service conditions may include water and other chemicals, temperature, stress, radiation, microorganisms, and other environmental factors.

3.1.7 *permanence, n*—the resistance of an adhesive bond to deteriorating influences.

(D 907)

3.1.8 *structural adhesive, n*—a bonding agent used for transferring required loads between adherends exposed to service environments typical for the structure involved.

(D 907)

3.2 Definitions of Terms Specific to This Standard:

3.2.1 *allowable shear modulus, n*—the modulus calculated in accordance with Section 14, that is used for the design of a structural joint.

3.2.2 *basic shear modulus, n*—the average shear modulus of 30 specimens fabricated and tested in accordance with 13.1.

3.2.3 *basic shear strength, n*—a near minimum value of the shear strength distribution determined as the one-sided lower confidence interval on the fifth percentile as determined in accordance with 7.1. (See lower 5 % tolerance limit.)

3.2.4 *basic tensile strength, n*—a near minimum value of the tensile strength distribution determined as the one-sided lower confidence interval on the fifth percentile as determined in accordance with 9.1. (See lower 5 % tolerance limit.)

3.2.5 *creep factor, n*—for modulus, the monotonic modulus as a function of loading rate expressed as the decimal fraction of the basic modulus.

3.2.6 *creep factor, n*—for strength, the estimated 30 year creep rupture limit as a decimal fraction of the basic strength.

3.2.7 *delamination factor, n*—a pass/fail factor based on the percentage of delamination on the end grain of a laminate after cyclic delamination treatment.

3.2.7.1 *Discussion*—The factor is 0 or 1: 0 if end-grain delamination is greater than 10 % of total end-grain bondline; 1 if less than 10 % after cyclic soak-dry treatment.

3.2.8 *durability factor, n*—the average strength under elevated test conditions expressed as a decimal fraction of the strength at standard condition.

3.2.8.1 *Discussion*—Increases in temperature and moisture level usually lower strength temporarily, as long as the specimen is not so weakened that fracture occurs. Decreases in temperature and moisture level usually increase strength. Exceptions occur when increasing the temperature raises the level of adhesive cure and strength, or decreasing the temperature or moisture induces brittleness and stress concentrations.

3.2.9 *lower 5 % nonparametric tolerance limit [NTL], n*—an estimate of the one-sided lower confidence bound on the fifth percentile of the strength distribution determined as the lowest ranked value (fast order statistic) of sample of specimens from a population.

3.2.10 *lower 5 % parametric tolerance limit [PTL], n*—an estimate of the lower confidence bound on the fifth percentile of the strength distribution calculated as the mean of a sample minus the sample standard deviation multiplied by a confidence level factor.

3.2.11 *lower 5 % tolerance limit, n*—an estimate of the one-sided lower confidence bound on the fifth percentile of the strength distribution of a population of specimens.

3.2.12 *modification factor, n*—any external or internal factor of the service environment that temporarily or permanently alters the strength or stiffness of an adhesive.

3.2.13 *multiaxial stress, n*—stress in two or three perpendicular directions, bi- or triaxial stress.

3.2.13.1 *Discussion*—In most wood structures bonded with structural adhesives, multiaxial stress consists of a shear stress in the plane of, and tension stress normal to the plane of the adhesive layer.

⁴ Annual Book of ASTM Standards, Vol 14.02.